

GR 00 P 1501 Foreign Version

19897

- 29 -

Patent Claims

1. A read/write amplifier for a DRAM memory cell (15), which, for evaluation of the information content of at least one DRAM memory cell (15), is connected or can be connected to at least one bit line (12) and to at least one reference bit line (13), which in each case form a bit line pair (16), having a number of components for assessment, amplification and forwarding of voltage signals read from the bit lines (12) and reference bit lines (13), in which case the read/write amplifier (30) has a first read/write amplifier element (40) and a second read/write amplifier element (50) separate therefrom, and in that the individual amplifier components are divided between the two read/write amplifier elements (40, 50).
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- 20 2. The read/write amplifier as claimed in claim 1, characterized in that the amplifier components have at least one N latch circuit (41; 51) for amplifying a voltage signal to a low level and/or at least one P latch circuit (42) for amplifying a voltage signal to a high level and/or at least one equalizer (43) for producing a reference voltage value on the bit line(s) (12) and the reference bit line(s) (13) and/or at least one bit switch (54) for connecting at least one selected bit line pair (16) to at least one external data line (31).
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- 30 3. The read/write amplifier as claimed in claim 2, characterized in that at least one N latch circuit (41) and at least one P latch circuit (42) are provided in the first read/write amplifier element (40).
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GR 00 P 1501 Foreign Version

19897

- 30 -

4. The read/write amplifier as claimed in claim 2 or
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characterized in that at least one equalizer (43)
is provided in the first read/write amplifier
element (40).
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5. The read/write amplifier as claimed in one of
claims 2 to 4, characterized in that at least one
N latch circuit (51) is provided in the second
read/write amplifier element (50).
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6. The read/write amplifier as claimed in one of
claims 2 to 5, characterized in that at least one
bit switch (54) is provided in the second
read/write amplifier element (50).
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7. The read/write amplifier as claimed in one of
claims 1 to 6, characterized in that the second
read/write amplifier element (50) is connected or
can be connected to at least one external data
line (31).
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8. The read/write amplifier as claimed in one of
claims 1 to 7, characterized in that the second
read/write amplifier element (50) is connected or
can be connected to at least one further
read/write amplifier (32).
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9. The read/write amplifier as claimed in one of
claims 1 to 8, characterized in that the first
(40) and/or second (50) read/write amplifier
element(s) has/have one or more transistors (45;
55) for changing over between different bit lines
(12) and reference bit lines (13), respectively.
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10. A DRAM memory, having a number of DRAM memory
cells (15), which each form one or more memory
cell arrays (11), each memory cell (15) being

GR 00 P 1501 Foreign Version

19897

- 31 -

connected to a bit line (12; 13) and the bit lines (12; 13) furthermore being connected to at least one read/write amplifier (20; 30), characterized in that the at least one read/write amplifier is
5 designed as a read/write amplifier (30) as claimed in one of claims 1 to 9.

11. The DRAM memory as claimed in claim 10, characterized in that at least one word line (14) is provided, which is routed across the memory cell array(s) (11) and, for activation of the DRAM memory cells (15), is connected to one or more memory cell(s) (15).
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12. The DRAM memory as claimed in claim 10 or 11, characterized in that a plurality of bit lines (12; 13) of a memory cell array (11) are connected to a read/write amplifier (30).
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13. The DRAM memory as claimed in one of claims 10 to 12, characterized in that in each case a bit line (12) of a DRAM memory cell (15) that is to be evaluated and a reference bit line (13) of a DRAM memory cell (15) that is not to be evaluated form a bit line pair (16), and in that each bit line pair (16) is connected both to the first (40) and to the second (50) read/write amplifier element.
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14. The DRAM memory as claimed in one of claims 10 to 30, characterized in that the connection of a bit line (12) and/or reference bit line (13) to a read/write amplifier (30) is activated or can be activated via one or more transistors (45; 55).
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15. A method for evaluating DRAM memory cells of a DRAM memory, in particular of a DRAM memory as claimed in one of claims 10 to 14, and in particular using a read/write amplifier as claimed
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GR 00 P 1501 Foreign Version

19897

- 32 -

in one of claims 1 to 9, having the following steps:

- a) activation of one or more memory cells that are to be evaluated via at least one word line;
- 5 b) activation of a connection of at least one first bit line pair, formed from a bit line of the memory cell that is to be evaluated and a reference bit line of a memory cell that is not to be evaluated, to a first read/write amplifier element, and activation of the connection of at least one second bit line pair, adjacent to the first bit line pair, to a second read/write amplifier element, the two bit line pairs in each case being connected to the first and second read/write amplifier elements;
- 10 c) amplification of the voltage signals read out via the first bit line pair by means of at least one N latch circuit provided in the first read/write amplifier element and also a P latch circuit, and amplification of the voltage signals read out via the second bit line pair by means of at least one N latch circuit provided in the second read/write amplifier element;
- 15 d) evaluation and writing back of the data of the memory cell(s) that is/are to be evaluated and is/are actively connected to the first read/write amplifier element;
- 20 e) changeover of the connection between the bit line pairs and the first read/write amplifier element in such a way that the P latch circuit of the first read/write amplifier element is changed over to the second read/write amplifier element;
- 25 f) evaluation and writing back of the data of the memory cell(s) that is/are to be evaluated and is/are actively connected to the second read/write amplifier element; and
- 30 g) deactivation of the memory cells that are to be evaluated.

GR 00 P 1501 Foreign Version

19897

- 33 -

16. The method as claimed in claim 15, characterized in that, before the evaluation of the memory cells, a uniform reference voltage is applied to all the bit lines of the memory cells provided in one or more memory cell array(s).
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17. The method as claimed in claim 15 or 16, characterized in that the bit line pair which is actively connected to the first read/write amplifier element is disconnected from the first read/write amplifier element after the end of step d), with the result that the bit line and the reference bit line float with full voltage levels, and in that the N latch circuit of the first read/write amplifier element is subsequently switched off.
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18. The method as claimed in one of claims 15 to 17, characterized in that, after the activation of a bit switch provided in the second read/write amplifier element, a voltage difference is generated on one or more external data line(s) connected to said bit switch.
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19. The method as claimed in one of claims 15 to 18, characterized in that, after the end of the evaluation operation, the uniform reference voltage is applied to all the bit lines of the evaluated memory cells via an equalizer.
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